



TUNNEL SERIES DIRECT-TO-AIR THERMOELECTRIC ASSEMBLY

The DA Tunnel Series is a Direct-to-Air thermoelectric assembly (TEA) that minimizes the number of airflow paths required to operate. It offers dependable, compact performance by cooling objects via conduction. Heat is absorbed and dissipated through a high density heat exchanger equipped with an air ducted shroud and a brand name fan. The thermoelectric modules are custom designed to achieve a high coefficient of performance (COP) to minimize power consumption. Custom configurations are available, however, MOQ applies.

FEATURES

- Tunnel Series compact design
- Precise temperature control
- Reliable solid-state operation
- DC operation
- RoHS compliant

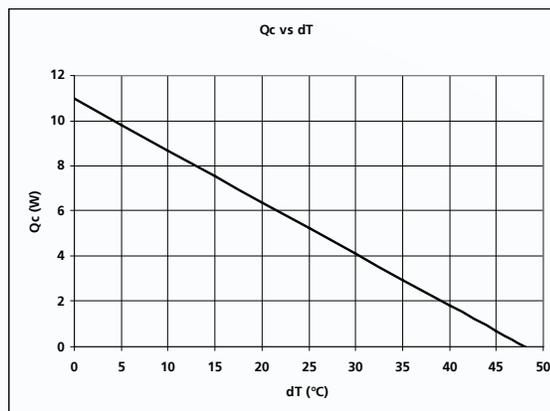
APPLICATIONS

- Analytical instrumentation
- Medical diagnostics
- Photonics laser systems
- Industrial instrumentation
- Food and beverage cooling

Specifications

Cooling Power Q_{cmax} (W)	11
Running Current (A)	2.2
Startup Current (A)	2.5
Nominal Voltage (V)	5
Max Voltage (V)	5.5
Power Input (W)	11
Operating Temperature (°C)	-10 to 55
Weight (kg)	0.2
MTBF (fans – hrs)	40,000
Performance Tolerance	±10%

PERFORMANCE CURVE



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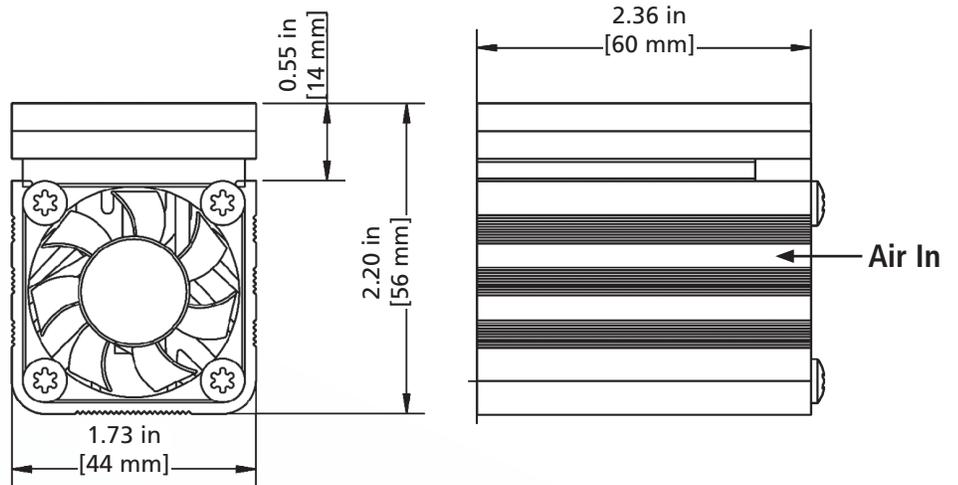
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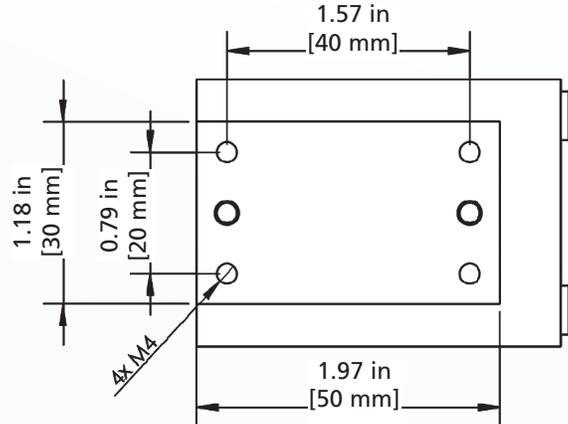
DA Tunnel Series, DA-011-05-02

Thermoelectric Assembly

ISOMETRIC DRAWINGS



MOUNTING HOLE LOCATION



WIRING SCHEMATIC

Electrical Connections	
"TEM+":	RED
"TEM-":	BLACK
"F+":	+ RED
"F-":	- BLACK OR BLUE

NOTES

Thermal grease included. For indoor use only.

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